


## HEXFRED® Ultrafast Soft Recovery Diode, 220 A



SOT-227

**FEATURES**

- Fast recovery time characteristic
- Electrically isolated base plate
- Large creepage distance between terminal
- Simplified mechanical designs, rapid assembly
- Designed and qualified for industrial level
- UL approved file E78996 
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS  
COMPLIANT**

PRODUCT SUMMARY	
$V_R$	1200 V
$V_F$ (typical)	2.68 V
$t_{rr}$ (typical)	58 ns
$I_{F(AV)}$ per module at $T_C$	220 A at 38 °C
Package	SOT-227

**DESCRIPTION/APPLICATIONS**

The dual diode series configuration (VS-HFA220FA120) is used for output rectification or freewheeling/clamping operation and high voltage application.

The semiconductor in the SOT-227 package is isolated from the copper base plate, allowing for common heatsinks and compact assemblies to be built.

These modules are intended for general applications such as HV power supplies, electronic welders, motor control and inverters.

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Cathode to anode voltage	$V_R$		1200	V
Continuous forward current <sup>(1)</sup>	$I_F$	$T_C = 68\text{ °C}$	110	A
Single pulse forward current	$I_{FSM}$	$T_J = 25\text{ °C}$	700	
Maximum power dissipation per leg	$P_D$	$T_C = 25\text{ °C}$	500	W
		$T_C = 100\text{ °C}$	400	
RMS isolation voltage	$V_{ISOL}$	Any terminal to case, $t = 1$ minute	2500	V
Operating junction and storage temperature range	$T_J, T_{Stg}$		- 55 to 150	°C

ELECTRICAL SPECIFICATIONS ( $T_J = 25\text{ °C}$ unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	$V_{BR}$	$I_R = 100\text{ }\mu\text{A}$	1200	-	-	V
Forward voltage	$V_{FM}$	$I_F = 100\text{ A}$	-	2.68	3.60	
		$I_F = 200\text{ A}$	-	3.41	4.70	
		$I_F = 100\text{ A}, T_J = 150\text{ °C}$	-	2.62	2.89	
		$I_F = 200\text{ A}, T_J = 150\text{ °C}$	-	3.59	3.89	
Reverse leakage current	$I_{RM}$	$V_R = V_R$ rated	-	10	75	$\mu\text{A}$
		$T_J = 125\text{ °C}, V_R = V_R$ rated	-	2	-	mA
		$T_J = 150\text{ °C}, V_R = V_R$ rated	-	6	15	

**Note**

<sup>(1)</sup> Maximum continuous forward current must be limited at 100 A to do not exceed the maximum temperature of power terminals.

<b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Reverse recovery time	$t_{rr}$	$I_F = 1\text{ A}$ ; $di_F/dt = -200\text{ A}/\mu\text{s}$ ; $V_R = 30\text{ V}$	-	58	-	ns
		$T_J = 25\text{ }^\circ\text{C}$	-	157	-	
		$T_J = 125\text{ }^\circ\text{C}$	-	255	-	
Peak recovery current	$I_{RRM}$	$T_J = 25\text{ }^\circ\text{C}$	-	15	-	A
		$T_J = 125\text{ }^\circ\text{C}$	-	22.5	-	
Reverse recovery charge	$Q_{rr}$	$T_J = 25\text{ }^\circ\text{C}$	-	1150	-	nC
		$T_J = 125\text{ }^\circ\text{C}$	-	2850	-	
Junction capacitance	$C_T$	$V_R = 1200\text{ V}$	-	53	-	pF

<b>THERMAL - MECHANICAL SPECIFICATIONS</b>						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Junction to case, single leg conducting	$R_{thJC}$		-	-	0.25	$^\circ\text{C}/\text{W}$
Junction to case, both legs conducting			-	-	0.125	
Case to heatsink	$R_{thCS}$	Flat, greased surface	-	0.10	-	g
Weight			-	30	-	g
Mounting torque			-	-	1.3	Nm
Case style			SOT-227			

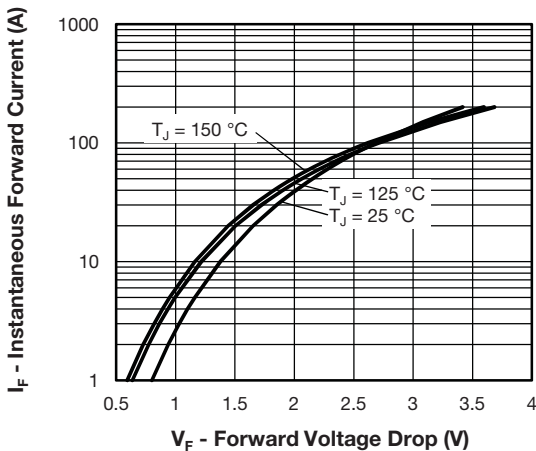


Fig. 1 - Typical Forward Voltage Drop Characteristics (Per Leg)

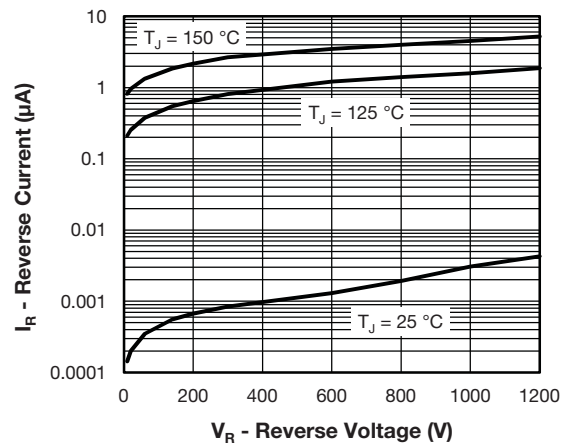


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

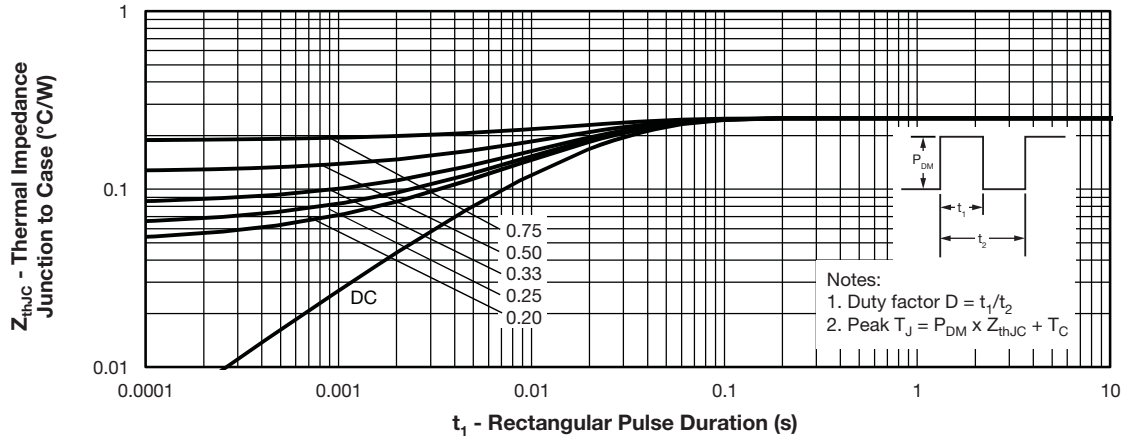


Fig. 3 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics (Per Leg)

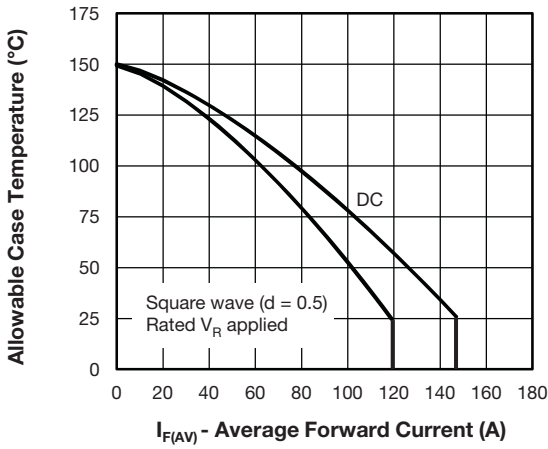


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

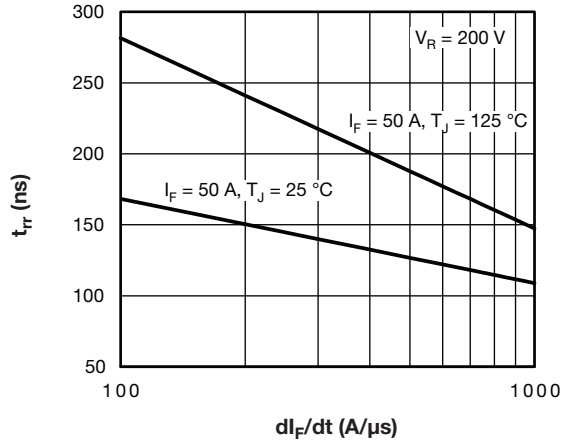


Fig. 6 - Typical Reverse Recovery Time vs.  $dI_F/dt$

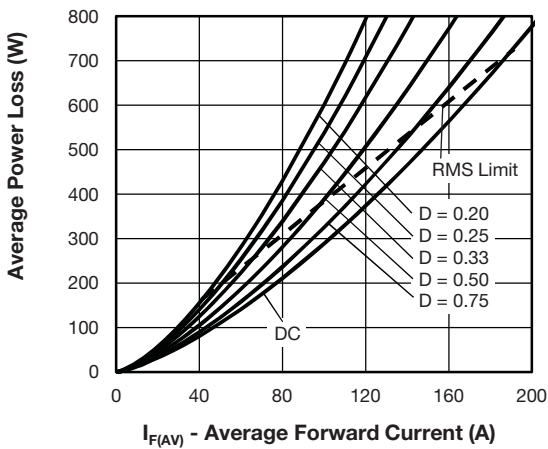


Fig. 5 - Forward Power Losses Characteristics (Per Leg)

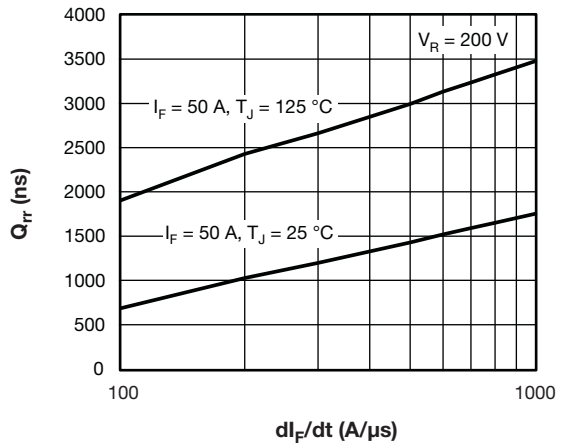


Fig. 7 - Typical Stored Charge vs.  $dI_F/dt$

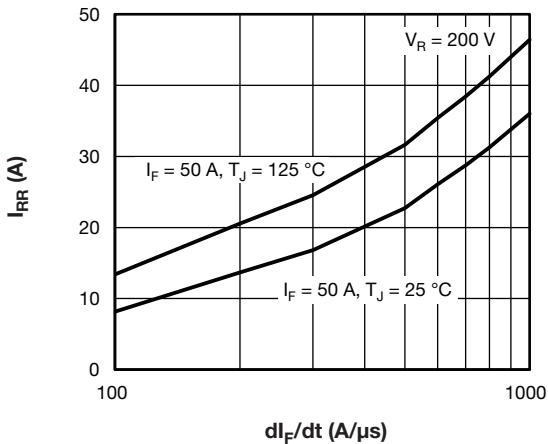


Fig. 8 - Typical Peak Recovery Current vs.  $di_F/dt$

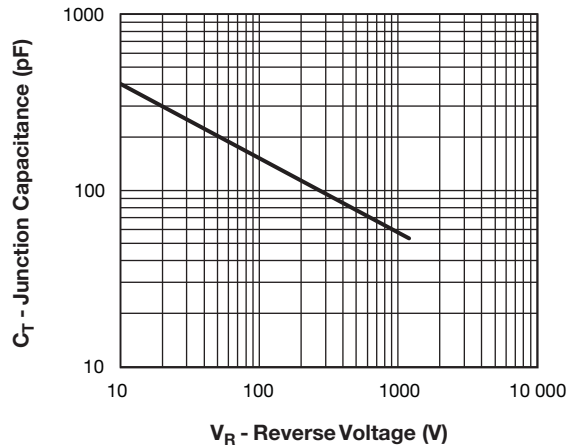


Fig. 9 - Typical Junction Capacitance vs. Reverse Voltage

**Note**

- (1) Formula used:  $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$ ;  
 $Pd$  = Forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see fig. 5);  
 $Pd_{REV}$  = Inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_{R1}$  = Rated  $V_R$

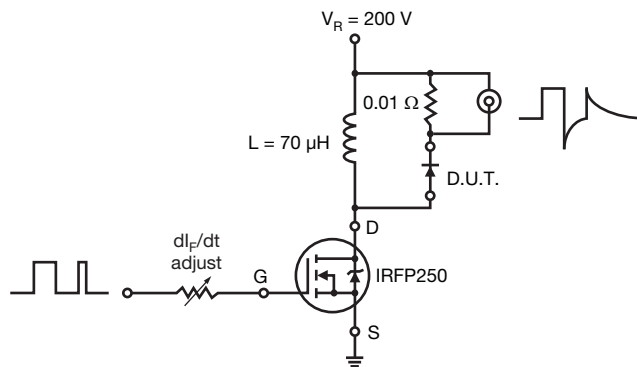
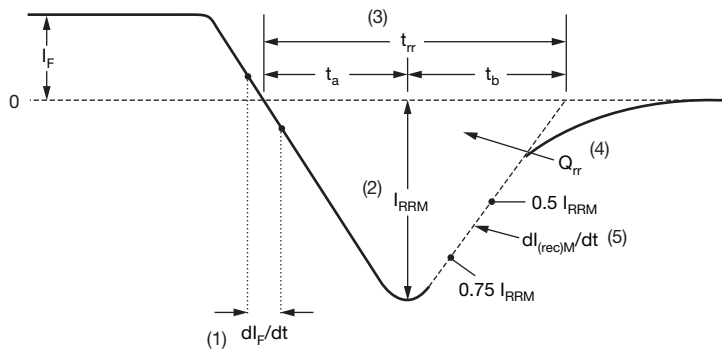


Fig. 10 - Reverse Recovery Parameter Test Circuit



- (1)  $di_F/dt$  - rate of change of current through zero crossing  
 (2)  $I_{RRM}$  - peak reverse recovery current  
 (3)  $t_{rr}$  - reverse recovery time measured from zero crossing point of negative going  $I_F$  to point where a line passing through  $0.75 I_{RRM}$  and  $0.50 I_{RRM}$  extrapolated to zero current  
 (4)  $Q_{rr}$  - area under curve defined by  $t_{rr}$  and  $I_{RRM}$   

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$
 (5)  $dl_{(rec)M}/dt$  - peak rate of change of current during  $t_b$  portion of  $t_{rr}$

Fig. 11 - Reverse Recovery Waveform and Definitions

## ORDERING INFORMATION TABLE

Device code	VS-	HF	A	220	F	A	120
	①	②	③	④	⑤	⑥	⑦

- 1** - Vishay Semiconductors product
- 2** - HEXFRED® family
- 3** - Process designator (A = Electron irradiated)
- 4** - Average current (220 = 220 A)
- 5** - Circuit configuration (2 separate diodes, parallel pin-out)
- 6** - Package indicator (SOT-227 standard insulated base)
- 7** - Voltage rating (120 = 1200 V)

CIRCUIT CONFIGURATION		
CIRCUIT	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING
2 separate diodes, parallel pin-out	F	<p>Lead Assignment</p>



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